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ON Semiconductor®

FDD3860

N-Channel PowerTrench[®] MOSFET 100 V, 29 A, 36 m Ω

Features

- Max $r_{DS(on)}$ = 36 m Ω at V_{GS} = 10 V, I_D = 5.9 A
- High Performance Trench Technology for Extremely Low r_{DS(on)}
- 100% UIL Tested
- RoHS Compliant

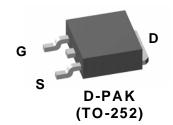


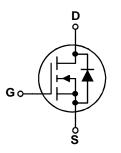
General Description

This N-Channel MOSFET is rugged gate version of ON Semiconductor's advanced Power Trench[®] process. This part is tailored for low $r_{DS(on)}$ and low Qg figure of merit, with avalanche ruggedness for a wide range of switching applications.

Applications

- DC-AC Conversion
- Synchronous Rectifier





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage			±20	V	
I _D	Drain Current -Continuous	$T_{C} = 25^{\circ}C$		29		
	-Continuous	T _A = 25°C	(Note 1a)	6.2	A	
	-Pulsed			60		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	121	mJ	
P _D	Power Dissipation	$T_{\rm C} = 25^{\circ}{\rm C}$		83	W	
	Power Dissipation	T _A = 25°C	(Note 1a)	3.75	VV	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +175	°C	

Thermal Characteristics

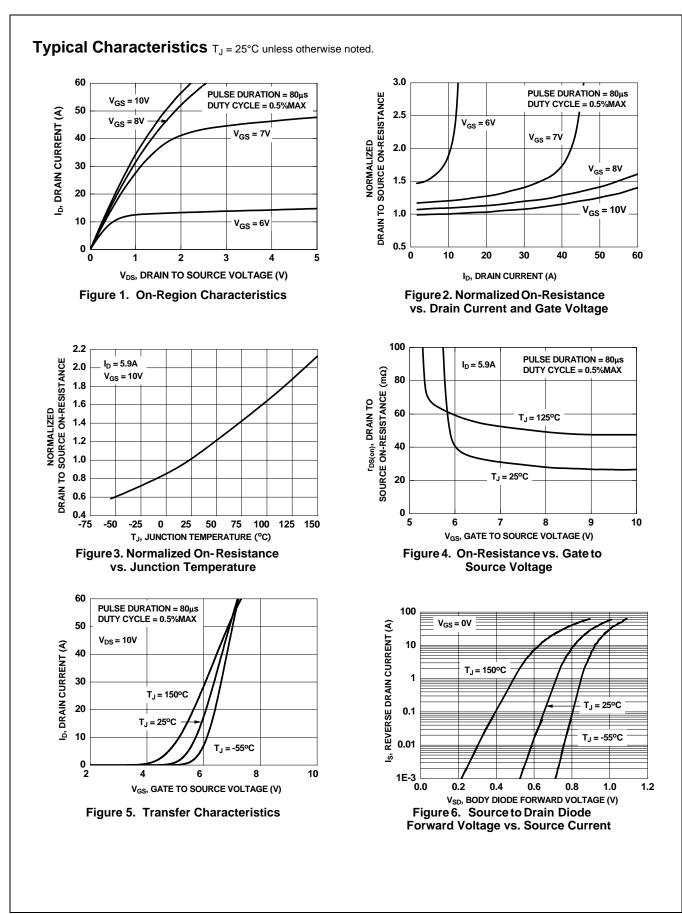
R_{\thetaJC}	Thermal Resistance, Junction to Case	1.8	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	40	C/ VV

Package Marking and Ordering Information

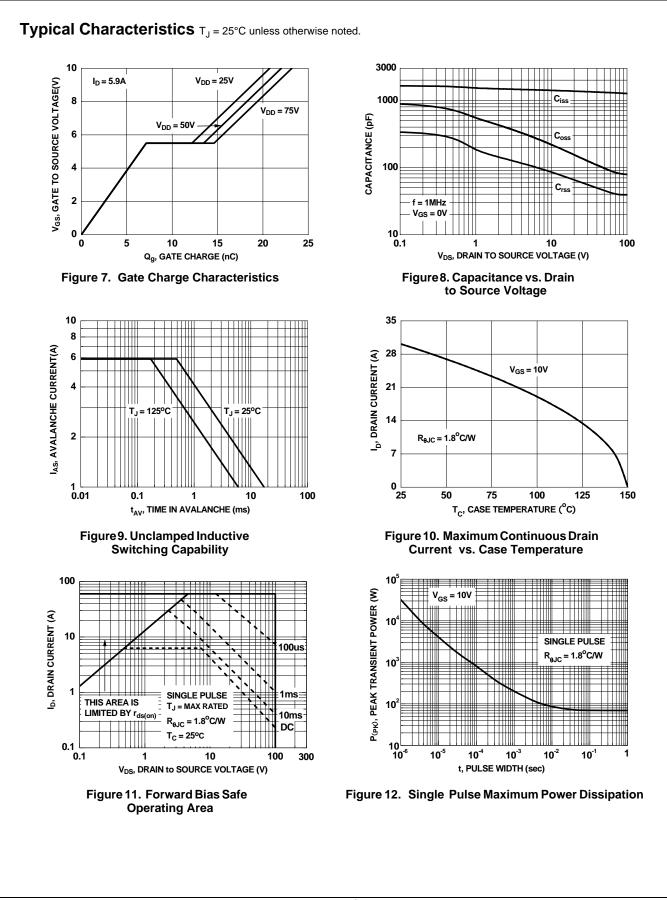
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD3860	FDD3860	D-PAK (TO-252)	13"	16 mm	2500 units

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{D} = 250 \mu A, V_{GS} = 0 V$	100			V
ΔBV _{DSS} ΔT _{.1}	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C		98		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 80V, V_{GS} = 0V$			1	μA
GSS	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
	-	65 / 55				
	Cate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2.5	3.8	4.5	V
/ _{GS(th)}	Gate to Source Threshold Voltage Gate to Source Threshold Voltage	$v_{GS} = v_{DS}, I_D = 250 \mu A$	2.0	3.0	4.5	v
∆V _{GS(th)} ∆TJ	Temperature Coefficient	$I_D = 250 \mu A$, referenced to $25^{\circ}C$		-11.4		mV/°C
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10V, I _D = 5.9A		29	36	mΩ
		$V_{GS} = 10V, I_D = 5.9A, T_J = 125^{\circ}C$		51	64	
Ĵfs	Forward Transconductance	$V_{DS} = 10V, I_{D} = 5.9A$		20		S
ynamic	Characteristics					
liss	Input Capacitance			1310	1740	pF
Soss	Output Capacitance	$V_{DS} = 50V, V_{GS} = 0V,$ f = 1MHz		100	130	pF
Srss	Reverse Transfer Capacitance			45	70	pF
Rg	Gate Resistance	f = 1MHz		1.6		Ω
	g Characteristics					
	Turn-On Delay Time			16	29	ns
d(on)	Rise Time	V _{DD} = 50V, I _D = 5.9A,		10	23	
r		$-V_{GS} = 10V, R_{GEN} = 6\Omega$		-		ns
d(off)	Turn-Off Delay Time			24	39	ns
f	Fall Time			7	15	ns
ζ ^g	Total Gate Charge at 10V	V _{DD} = 50V, I _D = 5.9A		22	31	nC
2 _{gs}	Gate to Source Charge			7.1		nC
2 _{gd}	Gate to Drain "Miller" Charge			6.3		nC
Drain-Sou	urce Diode Characteristics					
/ _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 2.0A$ (Note 2)		0.7	1.2	v
SD	Boarde to Brain Blode Torward Voltage	$V_{GS} = 0V, I_S = 5.9A$ (Note 2)		0.8	1.3	, , , , , , , , , , , , , , , , , , ,
rr	Reverse Recovery Time	L = 5.90 di/dt = 1000/us		34	55	ns
ک _{rr}	Reverse Recovery Charge	— I _F = 5.9A, di/dt = 100A/μs		40	64	nC
R _{6JC} is guara	um of the junction-to-case and case-to-ambient thermal resi anteed by design while $R_{0,JA}$ is determined by the user's box a) 40° C/W when module $1 \text{ in}^2 \text{ pad of } 2 \text{ oz } 10^{\circ}$ a) 40° C/W when module $1 \text{ in}^2 \text{ pad of } 2 \text{ oz } 10^{\circ}$ because values Width < 300μ s, Duty cycle < 2.0%. 25° C, L = 3mH, I _{AS} = 9A, V _{DD} = 100V, V _{GS} = 10V.	punted on a b) 96		en mounted		

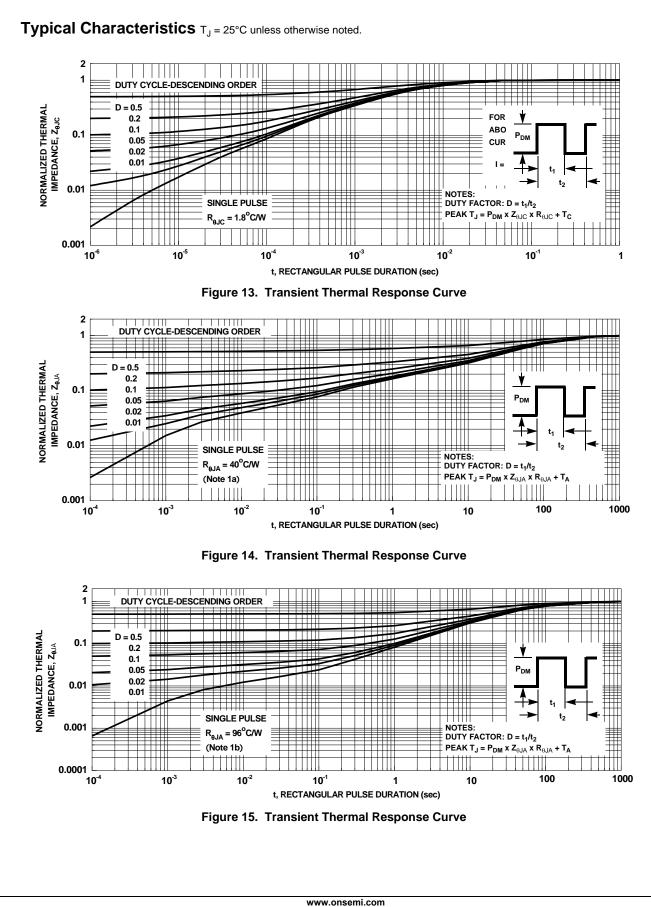
Electrical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted.



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FDD3860 N-Channel PowerTrench[®] MOSFET

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